

Serial No. NEW

OKI.217D

Preliminary Amendment dated July 24, 2003

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re Patent Application of :

Hidenori Hasegawa : Attn: Applications Branch

Divisional of Serial No.: 09/788,664 : Attorney Docket No. OKI.217D

Filed: July 24, 2003 :

For: SUBSTRATE FOR MOUNTING A SEMICONDUCTOR CHIP AND METHOD  
FOR MANUFACTURING A SEMICONDUCTOR DEVICE

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**PRELIMINARY AMENDMENT**

U.S. Patent and Trademark Office  
2011 South Clark Place  
Customer Window, **Mail Stop Patent Application**  
Crystal Plaza Two, Lobby, Room 1B03  
Arlington, VA 22202

Date: July 24, 2003

Sir:

Preliminary to the examination of the above-identified application, please enter  
the following amendments and remarks.

**Amendments to the Specification** begin on page 2 of this paper.

**Amendments to the Claims** are reflected in the listing of claims which begins  
on page 5 of this paper.